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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	80MHz
Connectivity	CANbus, Ethernet, I²C, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	85
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic32mx775f256lt-80i-pt">https://www.e-xfl.com/product-detail/microchip-technology/pic32mx775f256lt-80i-pt</a>

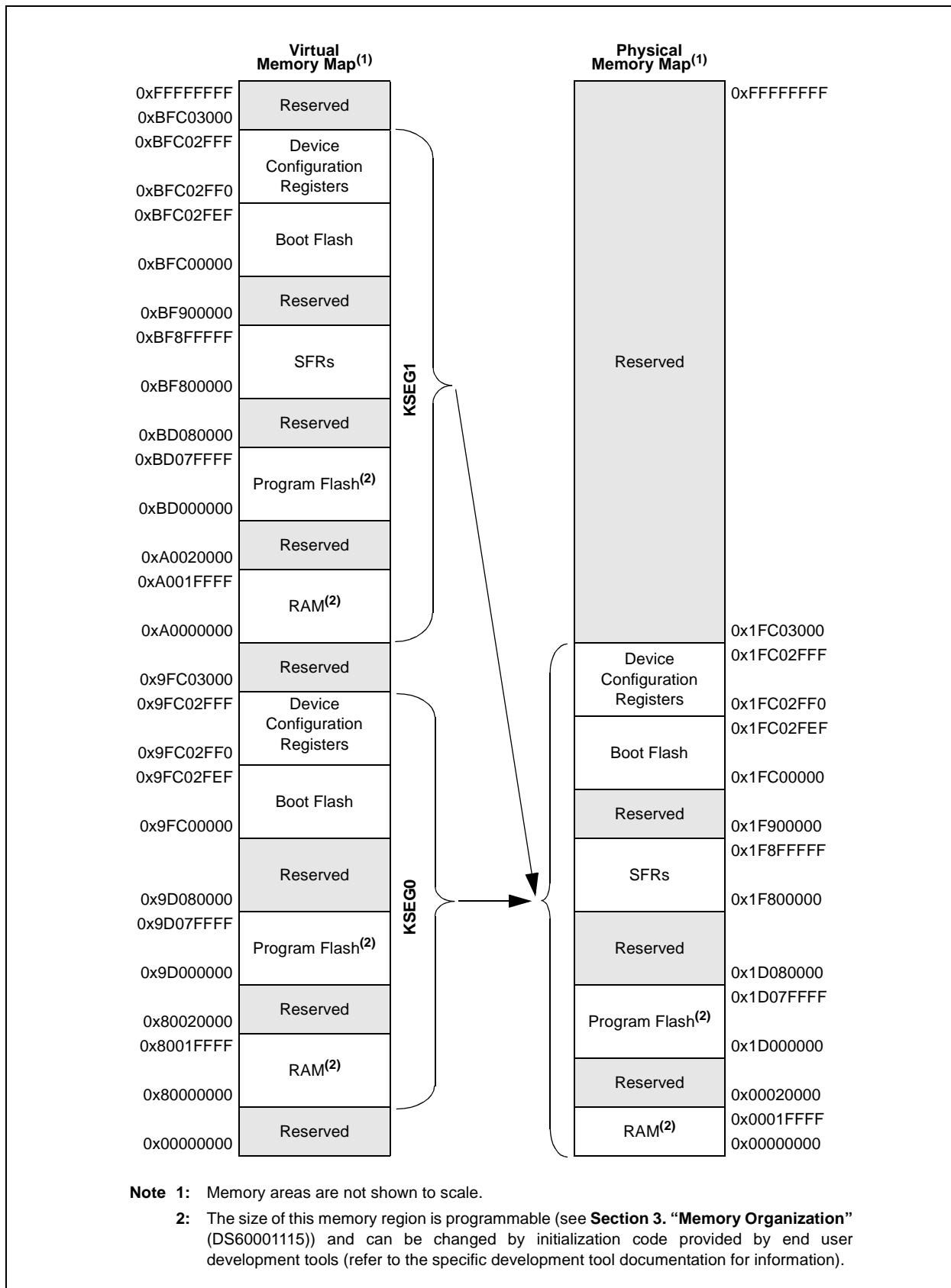
# PIC32MX5XX/6XX/7XX

**TABLE 13: PIN NAMES FOR 124-PIN USB, ETHERNET, AND CAN DEVICES (CONTINUED)**

124-PIN VTLA (BOTTOM VIEW) <sup>(2,3)</sup>		A17	B13	B29	A34
PIC32MX675F512L			B1	B41	Conductive Thermal Pad
PIC32MX695F512L			B56		A51
PIC32MX795F512L					
		A1			
				A68	
		Polarity Indicator			
Package Bump #	Full Pin Name				Package Bump #
B8	Vss				B33 TDO/RA5
B9	TMS/RA0				B34 OSC1/CLKI/RC12
B10	AERXD1/INT2/RE9				B35 No Connect (NC)
B11	AN4/C1IN-/CN6/RB4				B36 AETXCLK/SCL1/INT3/RA14
B12	Vss				B37 RTCC/EMDIO/AEMDIO/IC1/RD8
B13	AN2/C2IN-/CN4/RB2				B38 SCK1/IC3/PMCS2/PMA15/RD10
B14	PGED1/AN0/CN2/RB0				B39 SDO1/OC1/INT0/RD0
B15	No Connect (NC)				B40 SOSCO/T1CK/CN0/RC14
B16	PGED2/AN7/RB7				B41 Vss
B17	VREF+/CVREF+/AERXD3/PMA6/RA10				B42 OC3/RD2
B18	AVss				B43 ETXD2/IC5/PMD12/RD12
B19	AN9/C2OUT/RB9				B44 OC5/PMWR/CN13/RD4
B20	AN11/ERXERR/AETXERR/PMA12/RB11				B45 ETXEN/PMD14/CN15/RD6
B21	VDD				B46 Vss
B22	AC1TX/SCK4/U5TX/U2RTS/RF13				B47 No Connect (NC)
B23	AN12/ERXD0/AECRS/PMA11/RB12				B48 VCAP
B24	AN14/ERXD2/AETXD3/PMALH/PMA1/RB14				B49 C1RX <sup>(1)</sup> /ETXD1/PMD11/RF0
B25	Vss				B50 C2TX <sup>(1)</sup> /ETXERR/PMD9/RG1
B26	AETXD0/SS3/U4RX/U1CTS/CN20/RD14				B51 TRCLK/RA6
B27	SDA5/SDI4/U2RX/PMA9/CN17/RF4				B52 PMDO/RE0
B28	No Connect (NC)				B53 Vdd
B29	SCL3/SDO3/U1TX/RF8				B54 TRD2/RG14
B30	VUSB3V3				B55 TRD0/RG13
B31	D+/RG2				B56 PMD3/RE3

- Note**
- 1: This pin is only available on PIC32MX795F512L devices.
  - 2: Shaded package bumps are 5V tolerant.
  - 3: It is recommended that the user connect the printed circuit board (PCB) ground to the conductive thermal pad on the bottom of the package. And to not run non-Vss PCB traces under the conductive thermal pad on the same side of the PCB layout.

**FIGURE 4-6: MEMORY MAP ON RESET FOR PIC32MX695F512H, PIC32MX695F512L,  
PIC32MX795F512H AND PIC32MX795F512L DEVICES**











# PIC32MX5XX/6XX/7XX

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## REGISTER 11-5: U1PWRC: USB POWER CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
	UACTPND	—	—	USLPGRD	USBBUSY	—	USUSPEND	USBPWR

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7 **UACTPND:** USB Activity Pending bit

1 = USB bus activity has been detected; but an interrupt is pending, it has not been generated yet  
0 = An interrupt is not pending

bit 6-5 **Unimplemented:** Read as '0'

bit 4 **USLPGRD:** USB Sleep Entry Guard bit

1 = Sleep entry is blocked if USB bus activity is detected or if a notification is pending  
0 = USB module does not block Sleep entry

bit 3 **USBBUSY:** USB Module Busy bit

1 = USB module is active or disabled, but not ready to be enabled  
0 = USB module is not active and is ready to be enabled

**Note:** When USBPWR = 0 and USBBUSY = 1, status from all other registers is invalid and writes to all USB module registers produce undefined results.

bit 2 **Unimplemented:** Read as '0'

bit 1 **USUSPEND:** USB Suspend Mode bit

1 = USB module is placed in Suspend mode  
(The 48 MHz USB clock will be gated off. The transceiver is placed in a low-power state.)  
0 = USB module operates normally

bit 0 **USBPWR:** USB Operation Enable bit

1 = USB module is turned on  
0 = USB module is disabled  
(Outputs held inactive, device pins not used by USB, analog features are shut down to reduce power consumption.)

# PIC32MX5XX/6XX/7XX

## REGISTER 11-11: U1CON: USB CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R-x	R-x	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	JSTATE	SE0	PKTDIS <sup>(4)</sup> TOKBUSY <sup>(1,5)</sup>	USBRST	HOSTEN <sup>(2)</sup>	RESUME <sup>(3)</sup>	PPBRST	USBEN <sup>(4)</sup> SOFEN <sup>(5)</sup>

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7 **JSTATE:** Live Differential Receiver JSTATE flag bit

- 1 = JSTATE was detected on the USB
- 0 = JSTATE was not detected

bit 6 **SE0:** Live Single-Ended Zero flag bit

- 1 = Single-ended zero was detected on the USB
- 0 = Single-ended zero was not detected

bit 5 **PKTDIS:** Packet Transfer Disable bit<sup>(4)</sup>

- 1 = Token and packet processing disabled (set upon SETUP token received)
- 0 = Token and packet processing enabled

**TOKBUSY:** Token Busy Indicator bit<sup>(1,5)</sup>

- 1 = Token being executed by the USB module
- 0 = No token being executed

bit 4 **USBRST:** Module Reset bit<sup>(5)</sup>

- 1 = USB reset is generated
- 0 = USB reset is terminated

bit 3 **HOSTEN:** Host Mode Enable bit<sup>(2)</sup>

- 1 = USB host capability is enabled
- 0 = USB host capability is disabled

bit 2 **RESUME:** RESUME Signaling Enable bit<sup>(3)</sup>

- 1 = RESUME signaling is activated
- 0 = RESUME signaling is disabled

**Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 11-15).

**2:** All host control logic is reset any time that the value of this bit is toggled.

**3:** Software must set RESUME for 10 ms in Device mode, or for 25 ms in Host mode, and then clear it to enable remote wake-up. In Host mode, the USB module will append a low-speed EOP to the RESUME signaling when this bit is cleared.

**4:** Device mode.

**5:** Host mode.

# PIC32MX5XX/6XX/7XX

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## REGISTER 21-1: PMCON: PARALLEL PORT CONTROL REGISTER (CONTINUED)

bit 3 **CS1P:** Chip Select 0 Polarity bit<sup>(2)</sup>

1 = Active-high (PMCS1)

0 = Active-low (PMCS1)

bit 2 **Unimplemented:** Read as '0'

bit 1 **WRSP:** Write Strobe Polarity bit

For Slave Modes and Master mode 2 (PMMODE<9:8> = 00,01,10):

1 = Write strobe active-high (PMWR)

0 = Write strobe active-low (PMWR)

For Master mode 1 (PMMODE<9:8> = 11):

1 = Enable strobe active-high (PMENB)

0 = Enable strobe active-low (PMENB)

bit 0 **RDSP:** Read Strobe Polarity bit

For Slave modes and Master mode 2 (PMMODE<9:8> = 00,01,10):

1 = Read Strobe active-high (PMRD)

0 = Read Strobe active-low (PMRD)

For Master mode 1 (PMMODE<9:8> = 11):

1 = Read/write strobe active-high (PMRD/PMWWR)

0 = Read/write strobe active-low (PMRD/PMWWR)

**Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON control bit.

**2:** These bits have no effect when their corresponding pins are used as address lines.



# PIC32MX5XX/6XX/7XX

## REGISTER 24-2: CiCFG: CAN BAUD RATE CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	—	WAKFIL	—	—	—	SEG2PH<2:0> <sup>(1,4)</sup>		
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SEG2PHTS <sup>(1)</sup>	SAM <sup>(2)</sup>	SEG1PH<2:0>			PRSEG<2:0>		
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SJW<1:0> <sup>(3)</sup>		BRP<5:0>					

<b>Legend:</b>	HC = Hardware Clear	S = Settable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared      x = Bit is unknown

bit 31-23 **Unimplemented:** Read as '0'

bit 22 **WAKFIL:** CAN Bus Line Filter Enable bit

- 1 = Use CAN bus line filter for wake-up
- 0 = CAN bus line filter is not used for wake-up

bit 21-19 **Unimplemented:** Read as '0'

bit 18-16 **SEG2PH<2:0>:** Phase Buffer Segment 2 bits<sup>(1,4)</sup>

111 = Length is 8 x TQ

•  
•  
•

000 = Length is 1 x TQ

bit 15 **SEG2PHTS:** Phase Segment 2 Time Select bit<sup>(1)</sup>

- 1 = Freely programmable
- 0 = Maximum of SEG1PH or Information Processing Time, whichever is greater

bit 14 **SAM:** Sample of the CAN Bus Line bit<sup>(2)</sup>

- 1 = Bus line is sampled three times at the sample point
- 0 = Bus line is sampled once at the sample point

bit 13-11 **SEG1PH<2:0>:** Phase Buffer Segment 1 bits<sup>(4)</sup>

111 = Length is 8 x TQ

•  
•  
•

000 = Length is 1 x TQ

**Note 1:** SEG2PH ≤ SEG1PH. If SEG2PHTS is clear, SEG2PH will be set automatically.

- 2: 3 Time bit sampling is not allowed for BRP < 2.
- 3: SJW ≤ SEG2PH.
- 4: The Time Quanta per bit must be greater than 7 (that is, TQBIT > 7).

<b>Note:</b> This register can only be modified when the CAN module is in Configuration mode (OPMOD<2:0> (CiCON<23:21>) = 100 ).
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# PIC32MX5XX/6XX/7XX

## REGISTER 24-11: CiFLTCON1: CAN FILTER CONTROL REGISTER 1

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN7	MSEL7<1:0>						
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN6	MSEL6<1:0>						
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN5	MSEL5<1:0>						
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN4	MSEL4<1:0>						
<b>Legend:</b>								
R = Readable bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		

bit 31 **FLTEN7:** Filter 7 Enable bit

1 = Filter is enabled  
0 = Filter is disabled

bit 30-29 **MSEL7<1:0>:** Filter 7 Mask Select bits

11 = Acceptance Mask 3 selected  
10 = Acceptance Mask 2 selected  
01 = Acceptance Mask 1 selected  
00 = Acceptance Mask 0 selected

bit 28-24 **FSEL7<4:0>:** FIFO Selection bits

11111 = Message matching filter is stored in FIFO buffer 31  
11110 = Message matching filter is stored in FIFO buffer 30

•  
•  
•

00001 = Message matching filter is stored in FIFO buffer 1  
00000 = Message matching filter is stored in FIFO buffer 0

bit 23 **FLTEN6:** Filter 6 Enable bit

1 = Filter is enabled  
0 = Filter is disabled

bit 22-21 **MSEL6<1:0>:** Filter 6 Mask Select bits

11 = Acceptance Mask 3 selected  
10 = Acceptance Mask 2 selected  
01 = Acceptance Mask 1 selected  
00 = Acceptance Mask 0 selected

bit 20-16 **FSEL6<4:0>:** FIFO Selection bits

11111 = Message matching filter is stored in FIFO buffer 31

11110 = Message matching filter is stored in FIFO buffer 30

•  
•  
•

00001 = Message matching filter is stored in FIFO buffer 1  
00000 = Message matching filter is stored in FIFO buffer 0

**Note:** The bits in this register can only be modified if the corresponding filter enable (FLTENn) bit is '0'.

# PIC32MX5XX/6XX/7XX

## REGISTER 25-2: ETHCON2: ETHERNET CONTROLLER CONTROL REGISTER 2

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	—	—	—	—	—	RXBUFSZ<6:4>		
7:0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
	RXBUFSZ<3:0>				—	—	—	—

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-11    **Unimplemented:** Read as '0'

bit 10-4    **RXBUFSZ<6:0>:** RX Data Buffer Size for All RX Descriptors (in 16-byte increments) bits

1111111 = RX data Buffer size for descriptors is 2032 bytes

•

•

•

1100000 = RX data Buffer size for descriptors is 1536 bytes

•

•

•

0000011 = RX data Buffer size for descriptors is 48 bytes

0000010 = RX data Buffer size for descriptors is 32 bytes

0000001 = RX data Buffer size for descriptors is 16 bytes

0000000 = Reserved

bit 3-0    **Unimplemented:** Read as '0'

**Note 1:** This register is only used for RX operations.

**2:** The bits in this register may only be changed while the RXEN bit (ETHCON1<8>) = 0.

# PIC32MX5XX/6XX/7XX

## REGISTER 25-39: EMAC1SA2: ETHERNET CONTROLLER MAC STATION ADDRESS 2 REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P
	STNADDR2<7:0>							
7:0	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P
	STNADDR1<7:0>							

### Legend:

R = Readable bit

W = Writable bit

P = Programmable bit

-n = Value at POR

'1' = Bit is set

U = Unimplemented bit, read as '0'

'0' = Bit is cleared

x = Bit is unknown

bit 31-16 **Reserved**: Maintain as '0'; ignore read

bit 15-8 **STNADDR2<7:0>**: Station Address Octet 2 bits

These bits hold the second transmitted octet of the station address.

bit 7-0 **STNADDR1<7:0>**: Station Address Octet 1 bits

These bits hold the most significant (first transmitted) octet of the station address.

- Note 1:** Both 16-bit and 32-bit accesses are allowed to these registers (including the SET, CLR and INV registers). 8-bit accesses are not allowed and are ignored by the hardware.
- 2:** This register is loaded at reset from the factory preprogrammed station address.

## 29.2 On-Chip Voltage Regulator

All PIC32MX5XX/6XX/7XX devices' core and digital logic are designed to operate at a nominal 1.8V. To simplify system designs, most devices in the PIC32MX5XX/6XX/7XX family incorporate an on-chip regulator providing the required core logic voltage from VDD.

A low-ESR capacitor (such as tantalum) must be connected to the VCAP pin (see Figure 29-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in **Section 32.1 “DC Characteristics”**.

**Note:** It is important that the low-ESR capacitor is placed as close as possible to the VCAP pin.

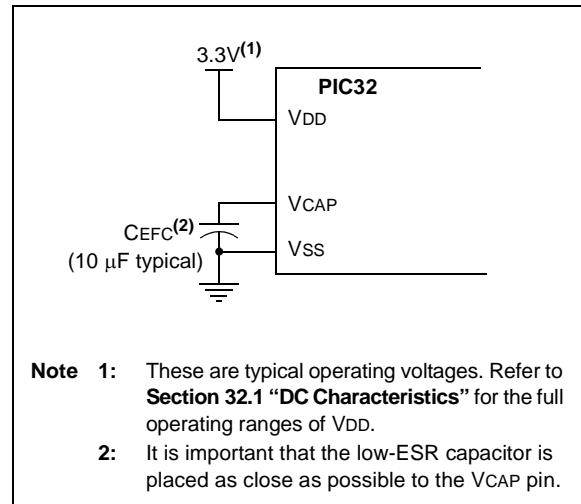
### 29.2.1 ON-CHIP REGULATOR AND POR

It takes a fixed delay for the on-chip regulator to generate an output. During this time, designated as TPU, code execution is disabled. TPU is applied every time the device resumes operation after any power-down, including Sleep mode.

### 29.2.2 ON-CHIP REGULATOR AND BOR

PIC32MX5XX/6XX/7XX devices also have a simple brown-out capability. If the voltage supplied to the regulator is inadequate to maintain a regulated level, the regulator Reset circuitry will generate a Brown-out Reset (BOR). This event is captured by the BOR flag bit (RCON<1>). The brown-out voltage levels are specified in **Section 32.1 “DC Characteristics”**.

**FIGURE 29-1: CONNECTIONS FOR THE ON-CHIP REGULATOR**



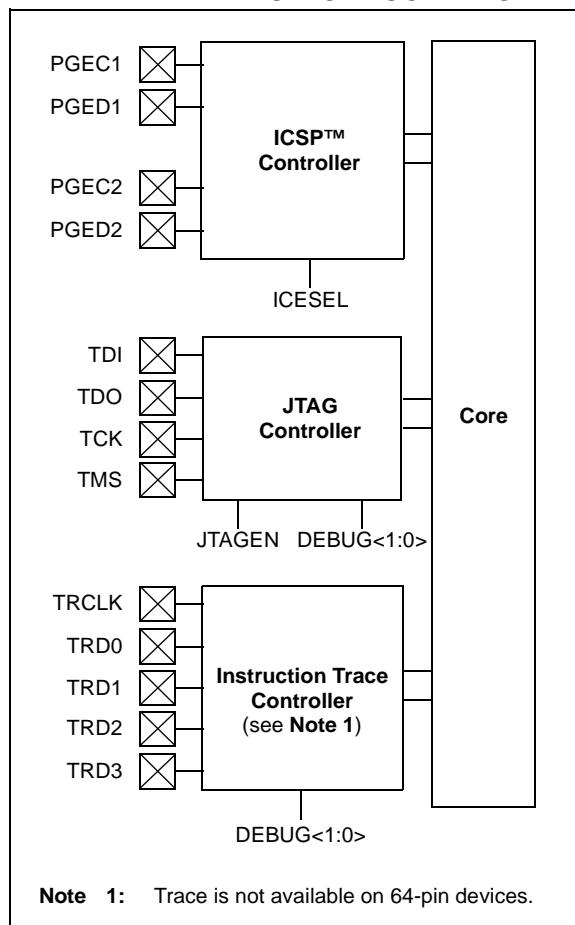
## 29.3 Programming and Diagnostics

PIC32MX5XX/6XX/7XX devices provide a complete range of programming and diagnostic features that can increase the flexibility of any application using them. These features allow system designers to include:

- Simplified field programmability using two-wire In-Circuit Serial Programming™ (ICSP™) interfaces
- Debugging using ICSP
- Programming and debugging capabilities using the EJTAG extension of JTAG
- JTAG boundary scan testing for device and board diagnostics

PIC32 devices incorporate two programming and diagnostic modules, and a trace controller, that provide a range of functions to the application developer.

**FIGURE 29-2: PROGRAMMING, DEBUGGING, AND TRACE PORTS BLOCK DIAGRAM**



**TABLE 32-17: EXTERNAL CLOCK TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics	Min.	Typical <sup>(1)</sup>	Max.	Units	Conditions
OS10	Fosc	External CLK1 Frequency (External clocks only allowed in EC and ECPPLL modes)	DC 4	—	50 50	MHz MHz	EC ( <b>Note 4</b> ) ECPPLL ( <b>Note 3</b> )
OS11		Oscillator Crystal Frequency	3	—	10	MHz	XT ( <b>Note 4</b> )
OS12			4	—	10	MHz	XTPPLL ( <b>Notes 3,4</b> )
OS13			10	—	25	MHz	HS ( <b>Note 4</b> )
OS14			10	—	25	MHz	HSPLL ( <b>Notes 3,4</b> )
OS15			32	32.768	100	kHz	Sosc ( <b>Note 4</b> )
OS20	Tosc	Tosc = 1/Fosc = Tcy <sup>(2)</sup>	—	—	—	—	See parameter OS10 for Fosc value
OS30	TosL, TosH	External Clock In (OSC1) High or Low Time	0.45 x Tosc	—	—	ns	EC ( <b>Note 4</b> )
OS31	TosR, TosF	External Clock In (OSC1) Rise or Fall Time	—	—	0.05 x Tosc	ns	EC ( <b>Note 4</b> )
OS40	Tost	Oscillator Start-up Timer Period (Only applies to HS, HSPLL, XT, XTPPLL and Sosc Clock Oscillator modes)	—	1024	—	Tosc	( <b>Note 4</b> )
OS41	TFSCM	Primary Clock Fail Safe Time-out Period	—	2	—	ms	( <b>Note 4</b> )
OS42	GM	External Oscillator Transconductance (Primary Oscillator only)	—	12	—	mA/V	VDD = 3.3V, TA = +25°C ( <b>Note 4</b> )

- Note 1:** Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are characterized but are not tested.
- 2:** Instruction cycle period (Tcy) equals the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLK1 pin.
- 3:** PLL input requirements:  $4 \text{ MHz} \leq \text{FPLLIN} \leq 5 \text{ MHz}$  (use PLL prescaler to reduce Fosc). This parameter is characterized, but is only tested at 10 MHz at manufacturing.
- 4:** This parameter is characterized, but not tested in manufacturing.

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**TABLE 32-36: ADC MODULE SPECIFICATIONS**

AC CHARACTERISTICS			Standard Operating Conditions (see Note 5): 2.5V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions
<b>Device Supply</b>							
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 2.5	—	Lesser of VDD + 0.3 or 3.6	V	—
AD02	AVss	Module Vss Supply	Vss	—	Vss + 0.3	V	—
<b>Reference Inputs</b>							
AD05	VREFH	Reference Voltage High	AVss + 2.0 2.5	—	AVDD 3.6	V V	(Note 1) VREFH = AVDD (Note 3)
AD05a				—	VREFH – 2.0	V	(Note 1)
AD06	VREFL	Reference Voltage Low	AVss	—	VREFL – 2.0	V	(Note 1)
AD07	VREF	Absolute Reference Voltage (VREFH – VREFL)	2.0	—	AVDD	V	(Note 3)
AD08	IREF	Current Drain	—	250	400	µA	ADC operating
AD08a			—	—	3	µA	ADC off
<b>Analog Input</b>							
AD12	VINH-VINL	Full-Scale Input Span	VREFL	—	VREFH	V	—
AD13	VINL	Absolute VINL Input Voltage	AVss – 0.3	—	AVDD/2	V	—
AD14	VIN	Absolute Input Voltage	AVss – 0.3	—	AVDD + 0.3	V	—
AD15		Leakage Current	—	±0.001	±0.610	µA	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V Source Impedance = 10 kΩ
AD17	RIN	Recommended Impedance of Analog Voltage Source	—	—	5K	Ω	(Note 1)
<b>ADC Accuracy – Measurements with External VREF+/VREF-</b>							
AD20c	Nr	Resolution	10 data bits			bits	—
AD21c	INL	Integral Nonlinearity	> -1	—	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD22c	DNL	Differential Nonlinearity	> -1	—	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V (Note 2)
AD23c	GERR	Gain Error	> -1	—	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD24c	EOFF	Offset Error	> -1	—	< 1	LSb	VINL = AVSS = 0V, AVDD = 3.3V
AD25c	—	Monotonicity	—	—	—	—	Guaranteed

**Note 1:** These parameters are not characterized or tested in manufacturing.

**2:** With no missing codes.

**3:** These parameters are characterized, but not tested in manufacturing.

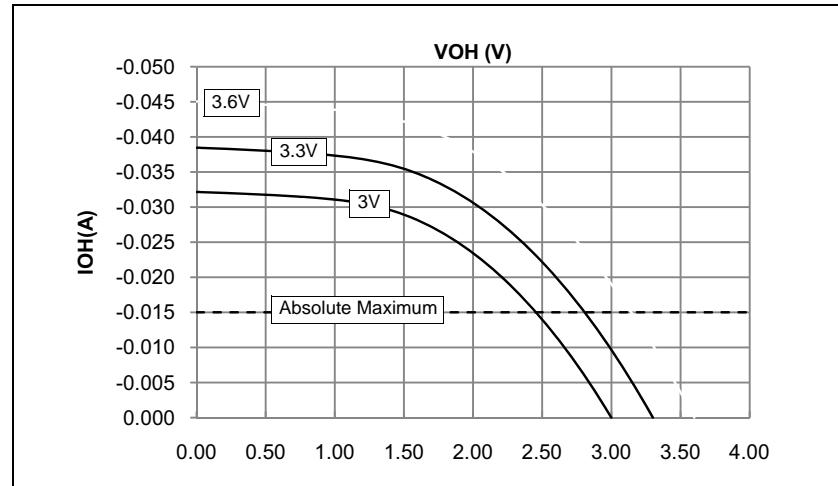
**4:** Characterized with a 1 kHz sine wave.

**5:** The ADC module is functional at  $V_{BORMIN} < VDD < 2.5V$ , but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

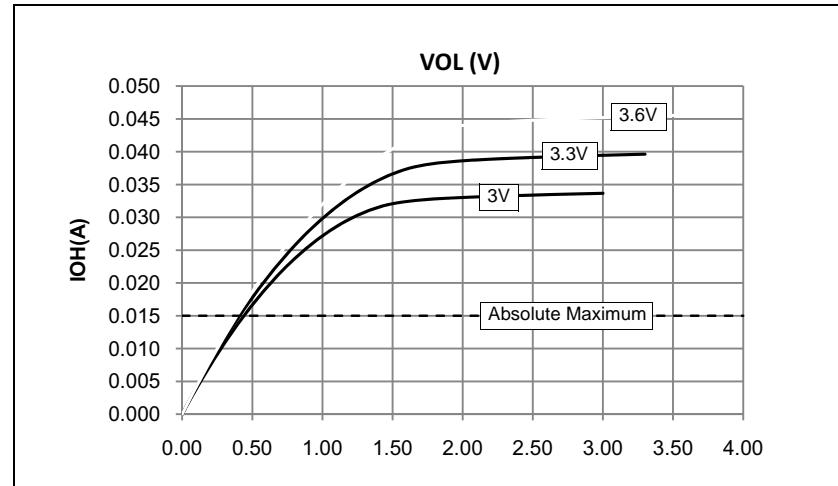
### 33.0 DC AND AC DEVICE CHARACTERISTICS GRAPHS

**Note:** The graphs provided following this note are a statistical summary based on a limited number of samples and are provided for design guidance purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

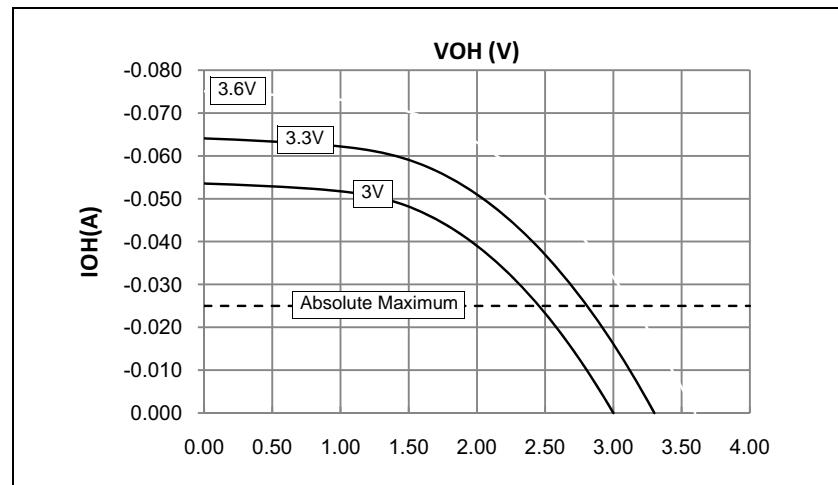
**FIGURE 33-1: VOH – 4x DRIVER PINS**



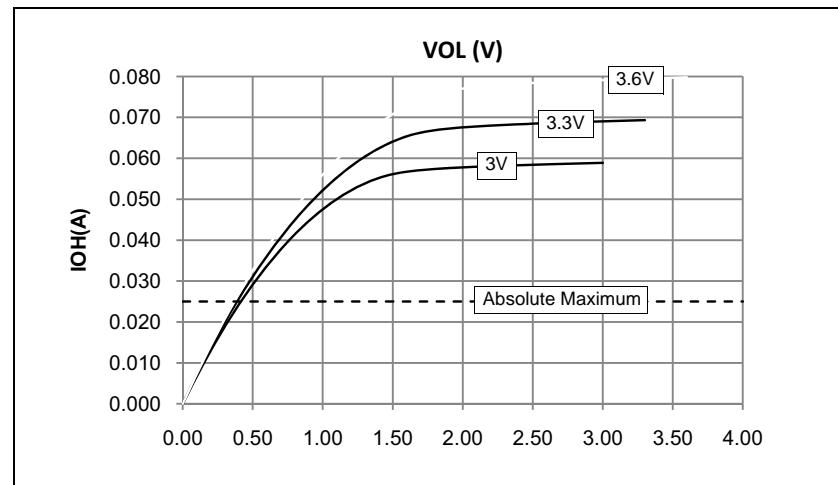
**FIGURE 33-3: VOL – 4x DRIVER PINS**



**FIGURE 33-2: VOH – 8x DRIVER PINS**



**FIGURE 33-4: VOL – 8x DRIVER PINS**



# **PIC32MX5XX/6XX/7XX**

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**NOTES:**

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**Note the following details of the code protection feature on Microchip devices:**

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